CLAUSE 5.2.2.2.2(a)(iii) – LOWER FLAMMABILITY SEALANT OR ADHESIVE (LIQUID OR THIXOTROPIC) MANDATORY FOR ALL ELECTRICAL PARTS OR ASSEMBLIES IN CONTACT WITH THE PRINTED CIRCUIT BOARD (PCB) OR FOR ALL PARTS OR ASSEMBLIES IN CONTACT WITH THE PCB WHICH ARE NOT RATED V-0 FOR FLAMMABILITY. – SEALANT OR ADHESIVE MUST BE RATED V-0 FOR FLAMMABILITY.
CLAUSE 5.2.2.2.2(a)(iii) – LOWER FLAMMABILITY SEALANT OR ADHESIVE (LIQUID OR THIXOTROPIC) MANDATORY FOR ALL ELECTRICAL PARTS OR ASSEMBLIES IN CONTACT WITH THE PRINTED CIRCUIT BOARD (PCB) OR FOR ALL PARTS OR ASSEMBLIES IN CONTACT WITH THE PCB WHICH ARE NOT RATED V-0 FOR FLAMMABILITY. – SEALANT OR ADHESIVE MUST BE RATED V-0 FOR FLAMMABILITY.